

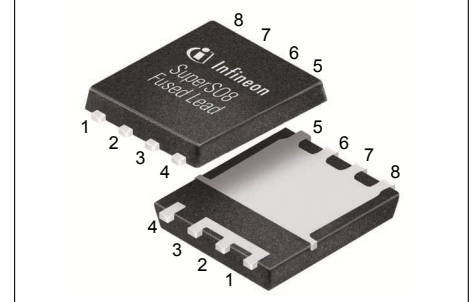
# MOSFET

## OptiMOS™ 5 Power-Transistor, 40 V

### Features

- Battery powered application
- LV motor drives
- Very low on-resistance  $R_{DS(on)}$
- 100% avalanche tested
- Superior thermal resistance
- N-channel
- Pb-free lead plating; RoHS compliant
- Halogen-free according to IEC61249-2-21
- 175 °C rated

TDSON-8 FL (enlarged source interconnection)

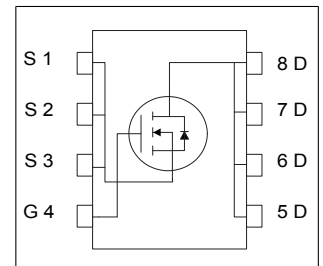


### Product validation

Fully qualified according to JEDEC for Industrial Applications

**Table 1 Key Performance Parameters**

| Parameter        | Value | Unit |
|------------------|-------|------|
| $V_{DS}$         | 40    | V    |
| $R_{DS(on),max}$ | 1.7   | mΩ   |
| $I_D$            | 193   | A    |
| $Q_{oss}$        | 54    | nC   |
| $Q_G(0V..10V)$   | 51    | nC   |



| Type / Ordering Code | Package    | Marking  | Related Links |
|----------------------|------------|----------|---------------|
| ISC017N04NM5         | TDSON-8 FL | 17N04NM5 | -             |

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## 1 Maximum ratings

at  $T_A=25\text{ °C}$ , unless otherwise specified

**Table 2 Maximum ratings**

| Parameter                                    | Symbol         | Values |      |                                | Unit | Note / Test Condition                                                                                                                                                                                                                                             |
|----------------------------------------------|----------------|--------|------|--------------------------------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|                                              |                | Min.   | Typ. | Max.                           |      |                                                                                                                                                                                                                                                                   |
| Continuous drain current <sup>1)</sup>       | $I_D$          | -      | -    | 193<br>137<br>178<br>126<br>31 | A    | $V_{GS}=10\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=7\text{ V}$ , $T_C=25\text{ °C}$<br>$V_{GS}=7\text{ V}$ , $T_C=100\text{ °C}$<br>$V_{GS}=10\text{ V}$ , $T_A=25\text{ °C}$ ,<br>$R_{THJA}=50\text{ °C/W}^{2)}$ |
| Pulsed drain current <sup>3)</sup>           | $I_{D,pulse}$  | -      | -    | 772                            | A    | $T_C=25\text{ °C}$                                                                                                                                                                                                                                                |
| Avalanche energy, single pulse <sup>4)</sup> | $E_{AS}$       | -      | -    | 220                            | mJ   | $I_D=50\text{ A}$ , $R_{GS}=25\text{ }\Omega$                                                                                                                                                                                                                     |
| Gate source voltage                          | $V_{GS}$       | -20    | -    | 20                             | V    | -                                                                                                                                                                                                                                                                 |
| Power dissipation                            | $P_{tot}$      | -      | -    | 115<br>3.0                     | W    | $T_C=25\text{ °C}$<br>$T_A=25\text{ °C}$ , $R_{THJA}=50\text{ °C/W}^{2)}$                                                                                                                                                                                         |
| Operating and storage temperature            | $T_j, T_{stg}$ | -55    | -    | 175                            | °C   | IEC climatic category; DIN IEC 68-1:<br>55/175/56                                                                                                                                                                                                                 |

## 2 Thermal characteristics

**Table 3 Thermal characteristics**

| Parameter                                     | Symbol     | Values |      |      | Unit | Note / Test Condition |
|-----------------------------------------------|------------|--------|------|------|------|-----------------------|
|                                               |            | Min.   | Typ. | Max. |      |                       |
| Thermal resistance, junction - case, bottom   | $R_{thJC}$ | -      | -    | 1.3  | °C/W | -                     |
| Thermal resistance, junction - case, top      | $R_{thJC}$ | -      | -    | 20   | °C/W | -                     |
| Device on PCB, 6 cm <sup>2</sup> cooling area | $R_{thJA}$ | -      | -    | 50   | °C/W | -                     |

<sup>1)</sup> Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher Tcase please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

<sup>2)</sup> Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm<sup>2</sup> (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

<sup>3)</sup> See Diagram 3 for more detailed information

<sup>4)</sup> See Diagram 13 for more detailed information

### 3 Electrical characteristics

at  $T_j=25\text{ °C}$ , unless otherwise specified

**Table 4 Static characteristics**

| Parameter                        | Symbol        | Values |            |            | Unit          | Note / Test Condition                                                                                                               |
|----------------------------------|---------------|--------|------------|------------|---------------|-------------------------------------------------------------------------------------------------------------------------------------|
|                                  |               | Min.   | Typ.       | Max.       |               |                                                                                                                                     |
| Drain-source breakdown voltage   | $V_{(BR)DSS}$ | 40     | -          | -          | V             | $V_{GS}=0\text{ V}$ , $I_D=1\text{ mA}$                                                                                             |
| Gate threshold voltage           | $V_{GS(th)}$  | 2.2    | -          | 3.4        | V             | $V_{DS}=V_{GS}$ , $I_D=60\text{ }\mu\text{A}$                                                                                       |
| Zero gate voltage drain current  | $I_{DSS}$     | -      | 0.1<br>10  | 1<br>100   | $\mu\text{A}$ | $V_{DS}=40\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=25\text{ °C}$<br>$V_{DS}=40\text{ V}$ , $V_{GS}=0\text{ V}$ , $T_j=125\text{ °C}$ |
| Gate-source leakage current      | $I_{GSS}$     | -      | 10         | 100        | nA            | $V_{GS}=20\text{ V}$ , $V_{DS}=0\text{ V}$                                                                                          |
| Drain-source on-state resistance | $R_{DS(on)}$  | -      | 1.3<br>1.5 | 1.7<br>2.0 | m $\Omega$    | $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$<br>$V_{GS}=7\text{ V}$ , $I_D=50\text{ A}$                                                 |
| Gate resistance                  | $R_G$         | -      | 0.9        | 1.3        | $\Omega$      | -                                                                                                                                   |
| Transconductance                 | $g_{fs}$      | -      | 210        | -          | S             | $ V_{DS} \geq 2 I_D /R_{DS(on)max}$ , $I_D=50\text{ A}$                                                                             |

**Table 5 Dynamic characteristics**

| Parameter                                  | Symbol       | Values |      |      | Unit | Note / Test Condition                                                                              |
|--------------------------------------------|--------------|--------|------|------|------|----------------------------------------------------------------------------------------------------|
|                                            |              | Min.   | Typ. | Max. |      |                                                                                                    |
| Input capacitance                          | $C_{iss}$    | -      | 3700 | 4800 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=20\text{ V}$ , $f=1\text{ MHz}$                                      |
| Output capacitance <sup>1)</sup>           | $C_{oss}$    | -      | 1690 | 2200 | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=20\text{ V}$ , $f=1\text{ MHz}$                                      |
| Reverse transfer capacitance <sup>1)</sup> | $C_{rss}$    | -      | 130  | 230  | pF   | $V_{GS}=0\text{ V}$ , $V_{DS}=20\text{ V}$ , $f=1\text{ MHz}$                                      |
| Turn-on delay time                         | $t_{d(on)}$  | -      | 10   | -    | ns   | $V_{DD}=20\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Rise time                                  | $t_r$        | -      | 5    | -    | ns   | $V_{DD}=20\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Turn-off delay time                        | $t_{d(off)}$ | -      | 20   | -    | ns   | $V_{DD}=20\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |
| Fall time                                  | $t_f$        | -      | 6    | -    | ns   | $V_{DD}=20\text{ V}$ , $V_{GS}=10\text{ V}$ , $I_D=50\text{ A}$ ,<br>$R_{G,ext}=1.6\text{ }\Omega$ |

**Table 6 Gate charge characteristics<sup>2)</sup>**

| Parameter                          | Symbol        | Values |      |      | Unit | Note / Test Condition                                                       |
|------------------------------------|---------------|--------|------|------|------|-----------------------------------------------------------------------------|
|                                    |               | Min.   | Typ. | Max. |      |                                                                             |
| Gate to source charge              | $Q_{gs}$      | -      | 16   | -    | nC   | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge at threshold           | $Q_{g(th)}$   | -      | 11   | -    | nC   | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate to drain charge <sup>1)</sup> | $Q_{gd}$      | -      | 9    | 14   | nC   | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Switching charge                   | $Q_{sw}$      | -      | 15   | -    | nC   | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge total <sup>1)</sup>    | $Q_g$         | -      | 51   | 67   | nC   | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate plateau voltage               | $V_{plateau}$ | -      | 4.2  | -    | V    | $V_{DD}=20\text{ V}$ , $I_D=50\text{ A}$ , $V_{GS}=0\text{ to }10\text{ V}$ |
| Gate charge total, sync. FET       | $Q_{g(sync)}$ | -      | 46   | -    | nC   | $V_{DS}=0.1\text{ V}$ , $V_{GS}=0\text{ to }10\text{ V}$                    |
| Output charge                      | $Q_{oss}$     | -      | 54   | -    | nC   | $V_{DD}=20\text{ V}$ , $V_{GS}=0\text{ V}$                                  |

<sup>1)</sup> Defined by design. Not subject to production test.

<sup>2)</sup> See "Gate charge waveforms" for parameter definition

**Table 7 Reverse diode**

| Parameter                        | Symbol        | Values |      |      | Unit | Note / Test Condition                                                      |
|----------------------------------|---------------|--------|------|------|------|----------------------------------------------------------------------------|
|                                  |               | Min.   | Typ. | Max. |      |                                                                            |
| Diode continuous forward current | $I_S$         | -      | -    | 115  | A    | $T_C=25\text{ °C}$                                                         |
| Diode pulse current              | $I_{S,pulse}$ | -      | -    | 772  | A    | $T_C=25\text{ °C}$                                                         |
| Diode forward voltage            | $V_{SD}$      | -      | 0.83 | 1    | V    | $V_{GS}=0\text{ V}$ , $I_F=50\text{ A}$ , $T_j=25\text{ °C}$               |
| Reverse recovery time            | $t_{rr}$      | -      | 52   | -    | ns   | $V_R=20\text{ V}$ , $I_F=50\text{ A}$ , $di_F/dt=100\text{ A}/\mu\text{s}$ |
| Reverse recovery charge          | $Q_{rr}$      | -      | 59   | -    | nC   | $V_R=20\text{ V}$ , $I_F=50\text{ A}$ , $di_F/dt=100\text{ A}/\mu\text{s}$ |

## 4 Electrical characteristics diagrams

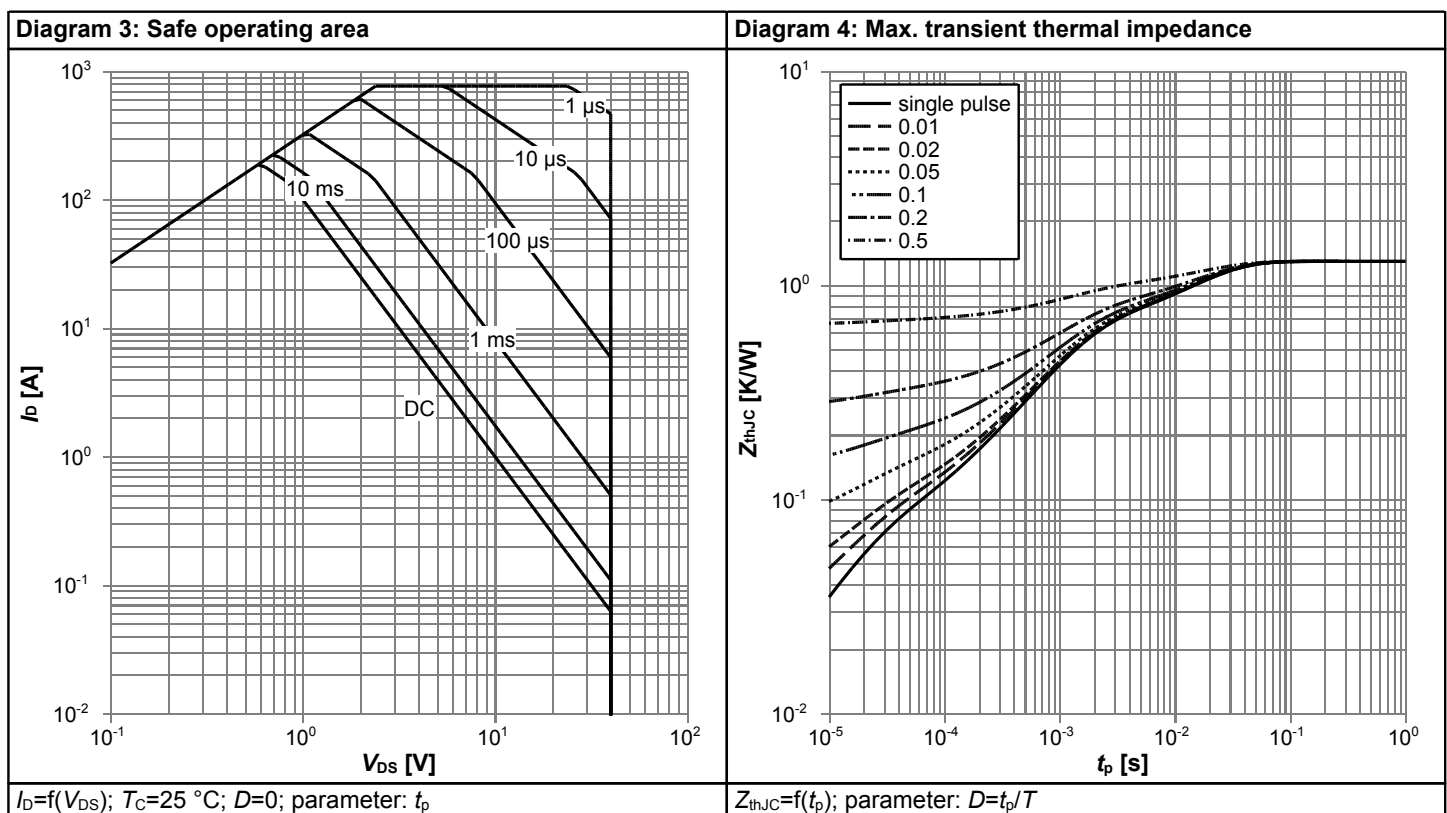
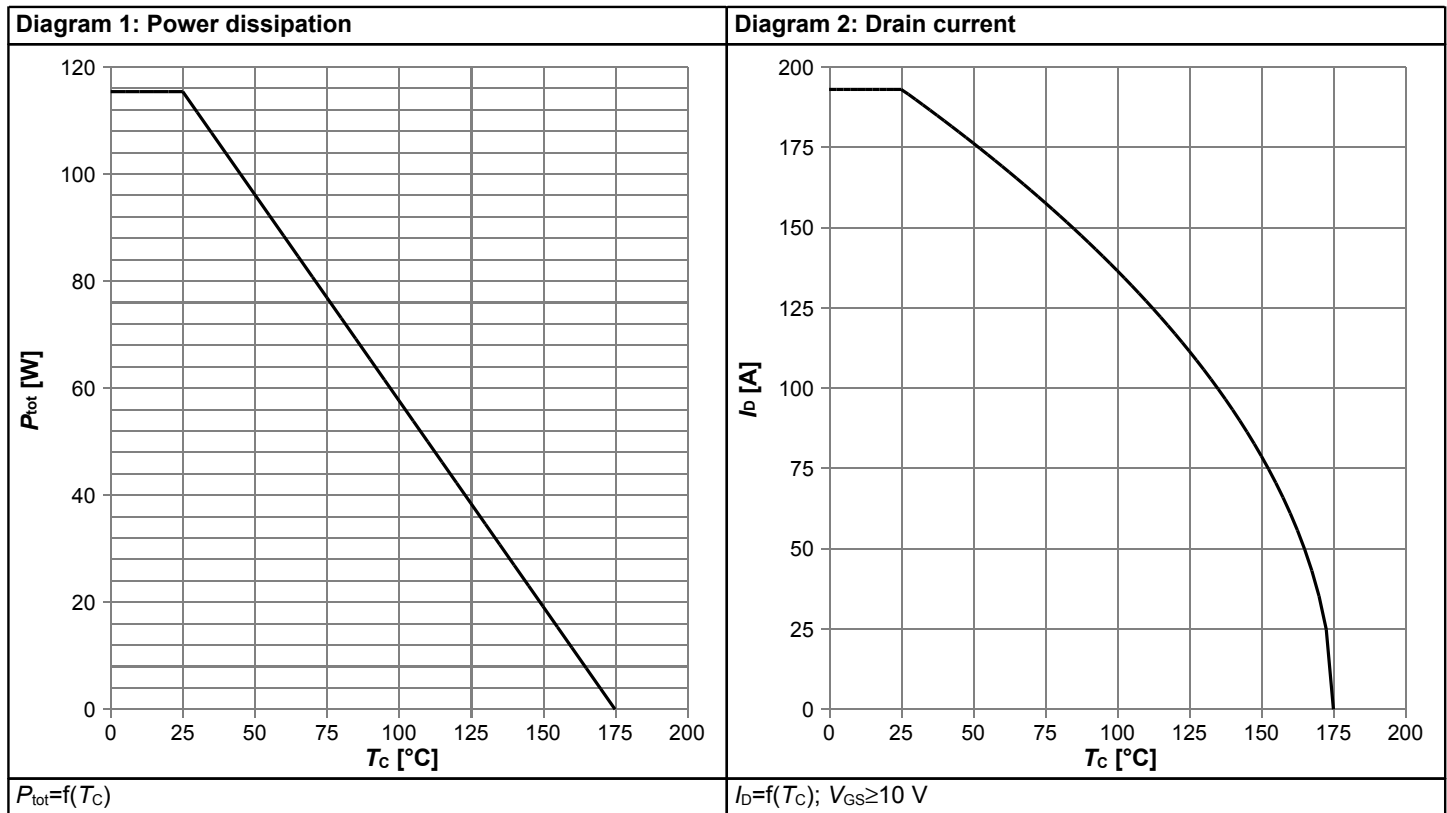
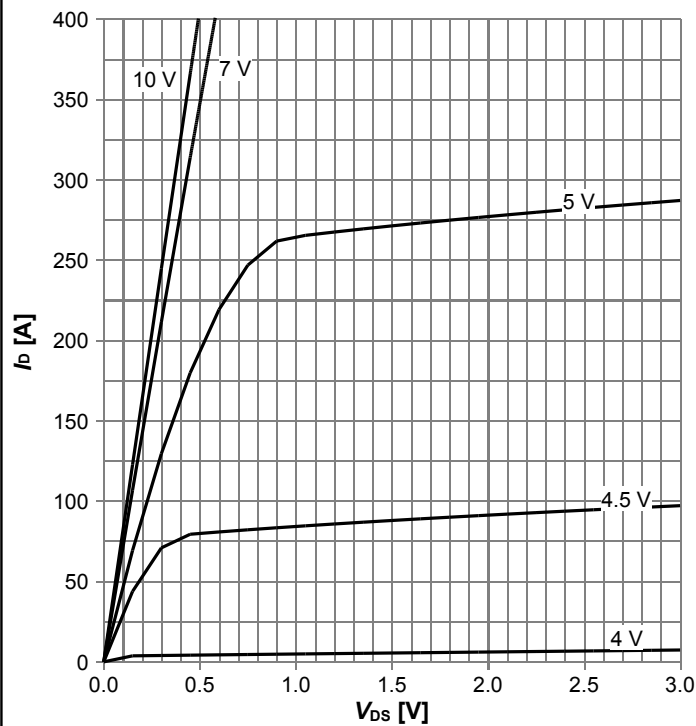
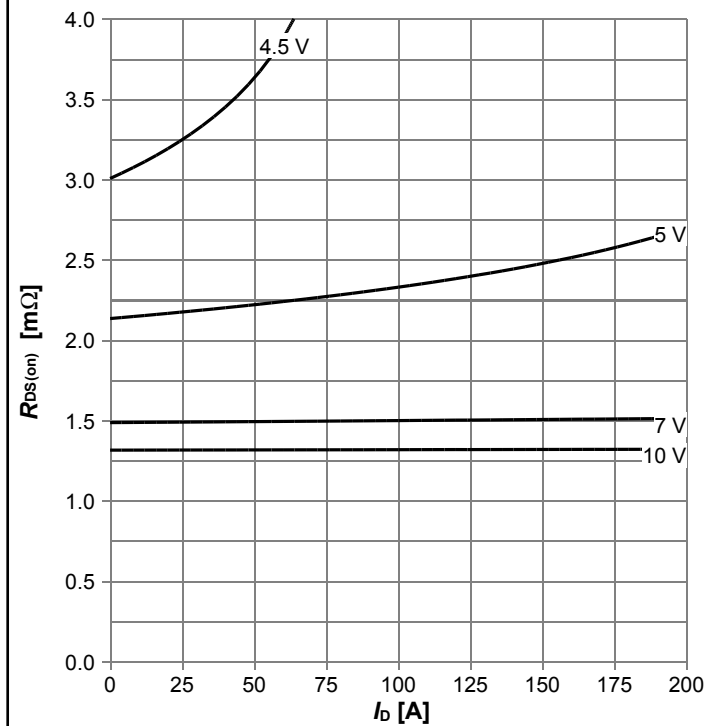


Diagram 5: Typ. output characteristics



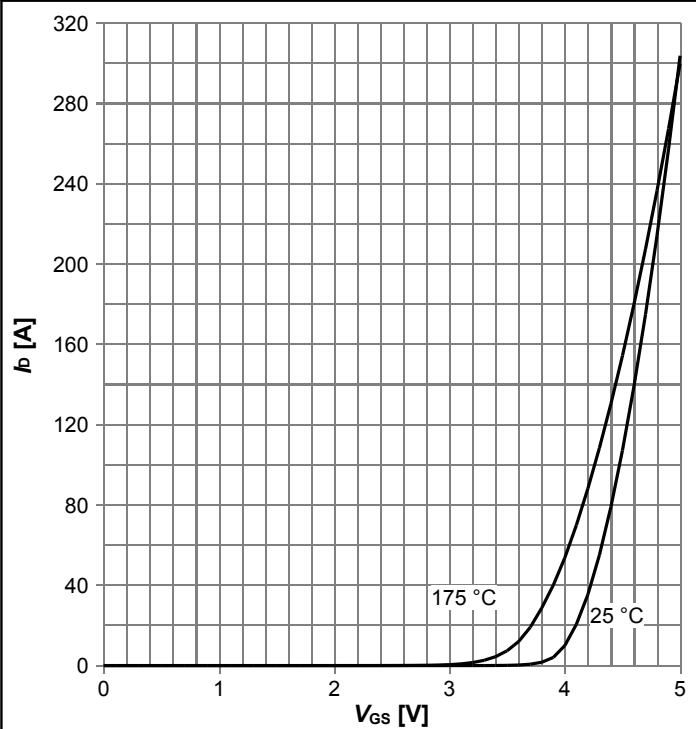
$I_D = f(V_{DS})$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 6: Typ. drain-source on resistance



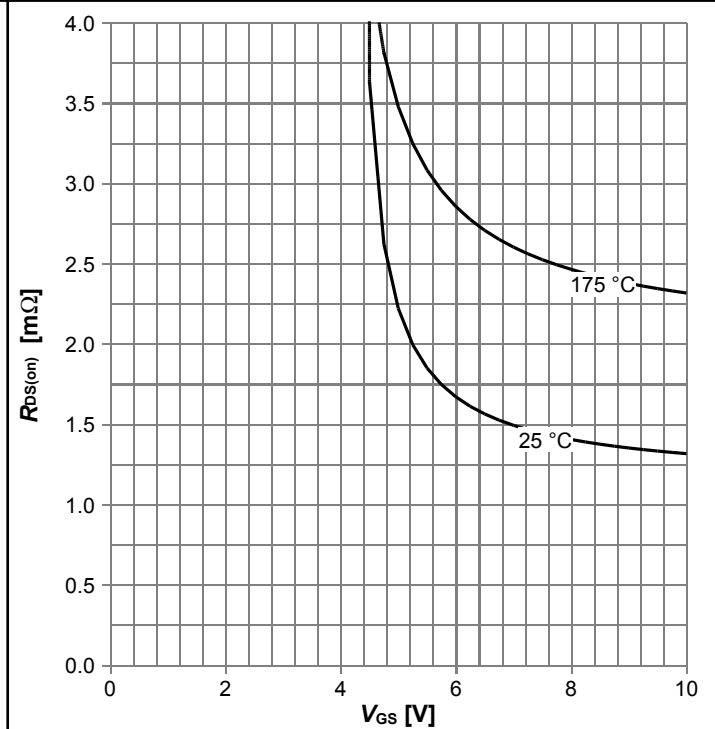
$R_{DS(on)} = f(I_D)$ ,  $T_j = 25^\circ\text{C}$ ; parameter:  $V_{GS}$

Diagram 7: Typ. transfer characteristics



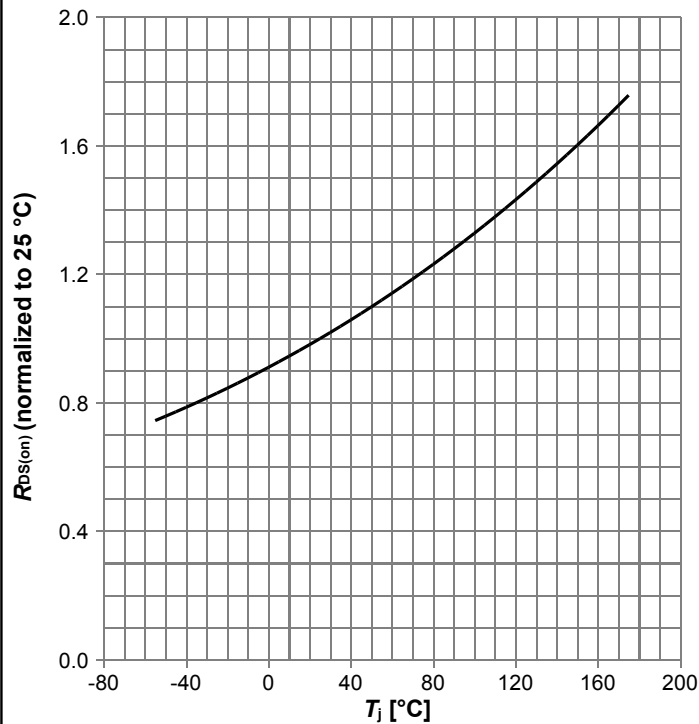
$I_D = f(V_{GS})$ ,  $|V_{DS}| > 2|I_D|R_{DS(on)max}$ ; parameter:  $T_j$

Diagram 8: Typ. drain-source on resistance



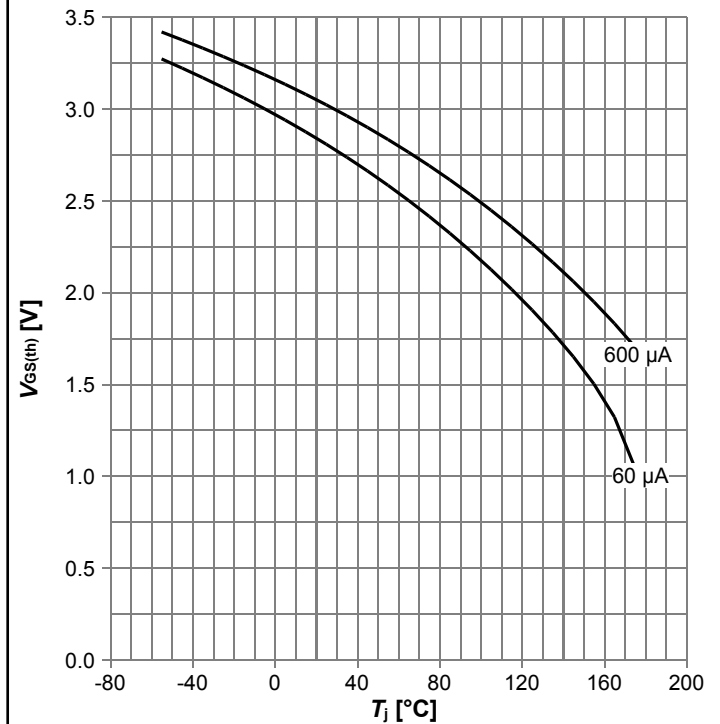
$R_{DS(on)} = f(V_{GS})$ ,  $I_D = 50$  A; parameter:  $T_j$

Diagram 9: Normalized drain-source on resistance



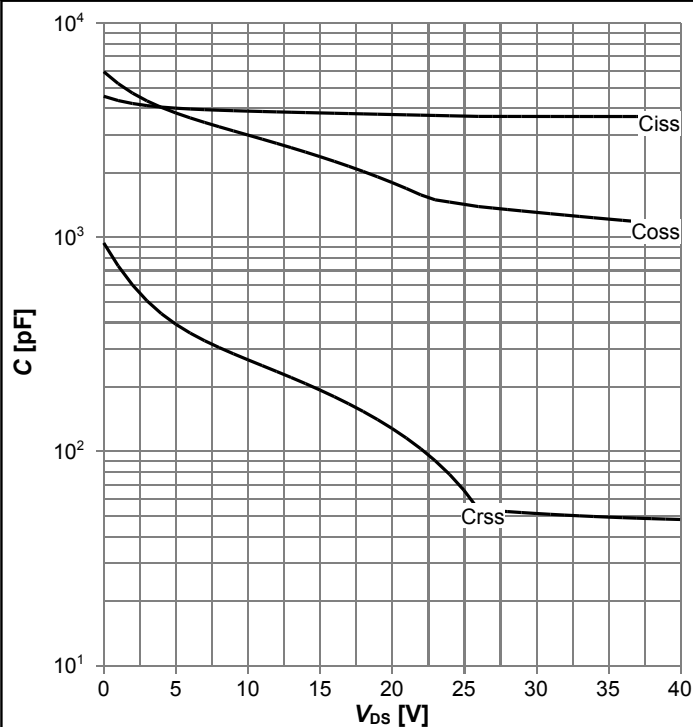
$R_{DS(on)} = f(T_j)$ ,  $I_D = 50$  A,  $V_{GS} = 10$  V

Diagram 10: Typ. gate threshold voltage



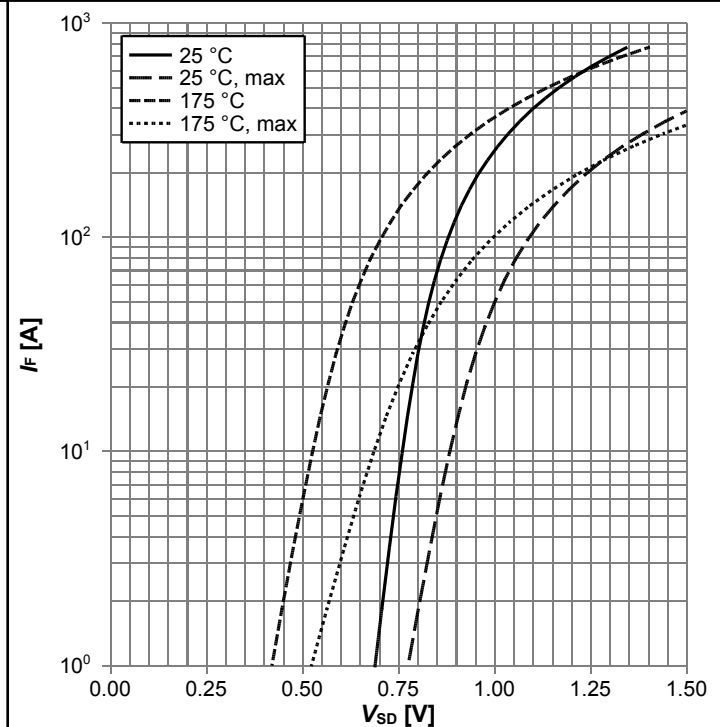
$V_{GS(th)} = f(T_j)$ ,  $V_{GS} = V_{DS}$ ; parameter:  $I_D$

Diagram 11: Typ. capacitances



$C = f(V_{DS})$ ;  $V_{GS} = 0$  V;  $f = 1$  MHz

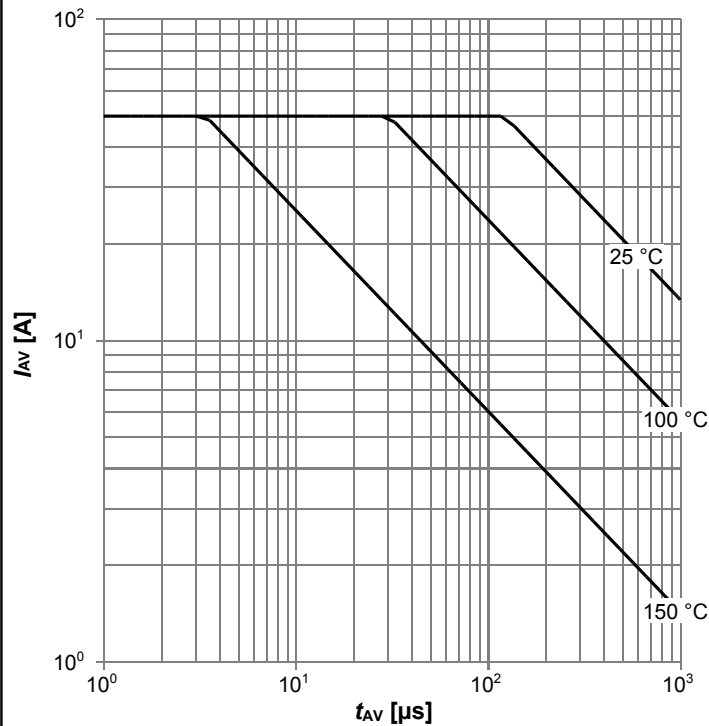
Diagram 12: Forward characteristics of reverse diode



$I_F = f(V_{SD})$ ; parameter:  $T_j$

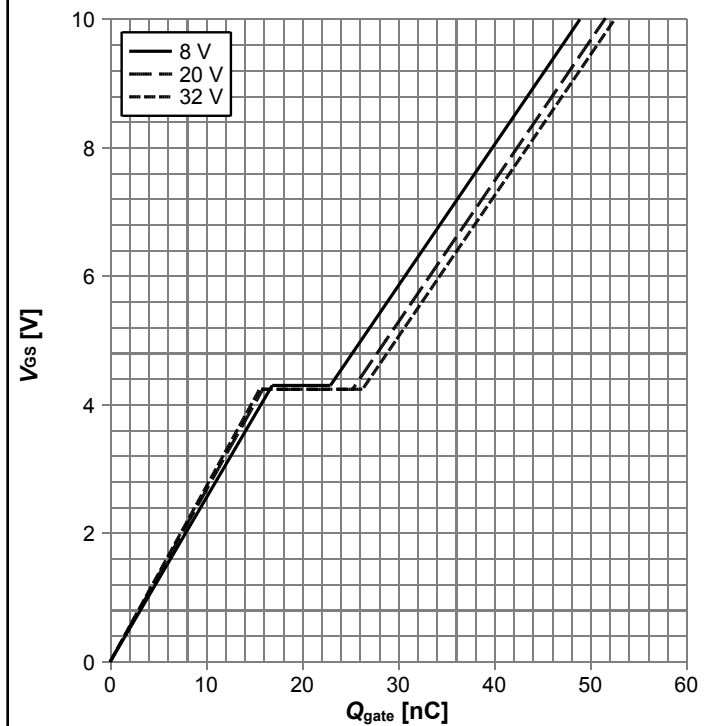


Diagram 13: Avalanche characteristics



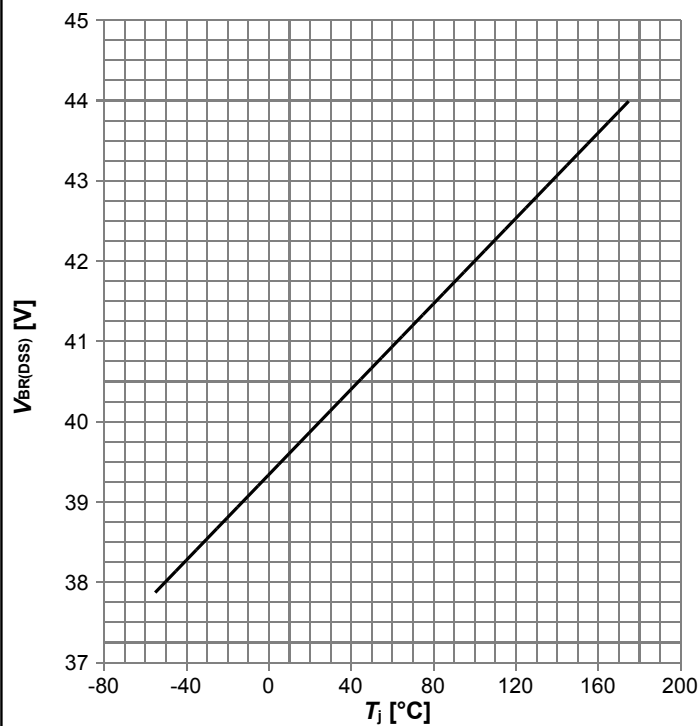
$I_{AS}=f(t_{AV})$ ;  $R_{GS}=25 \Omega$ ; parameter:  $T_{j,start}$

Diagram 14: Typ. gate charge



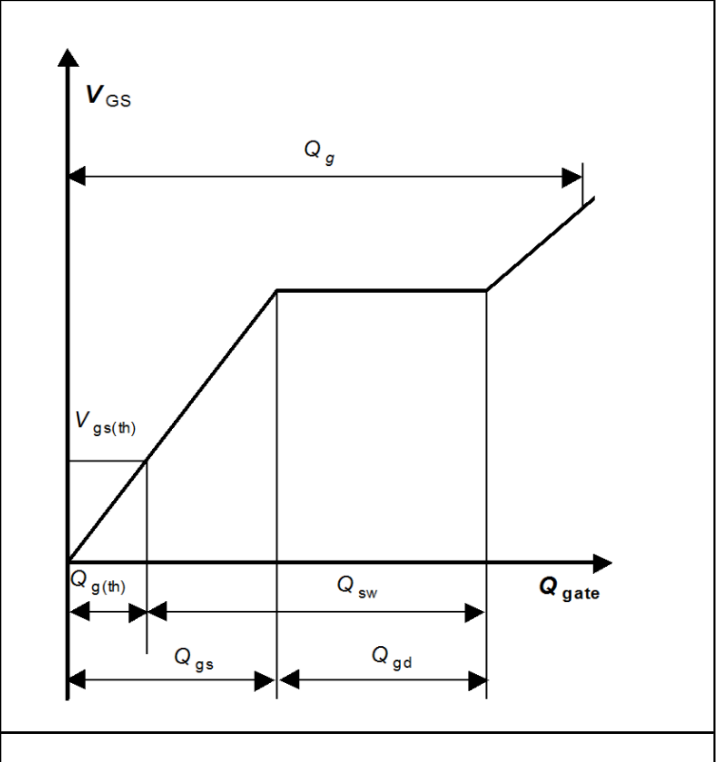
$V_{GS}=f(Q_{gate})$ ,  $I_D=50$  A pulsed,  $T_j=25$  °C; parameter:  $V_{DD}$

Diagram 15: Drain-source breakdown voltage



$V_{BR(DSS)}=f(T_j)$ ;  $I_D=1$  mA

Diagram Gate charge waveforms



## 5 Package Outlines

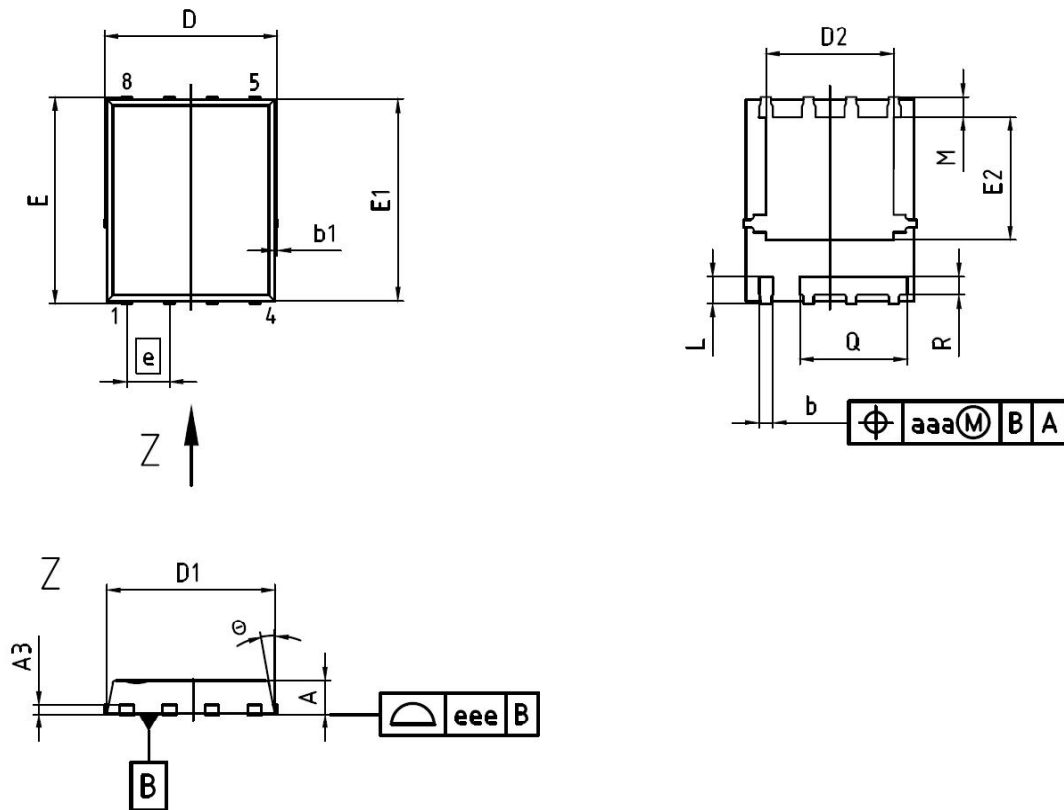


Figure 1 Outline TDSON-8 FL, dimensions in mm/inches

## Revision History

ISC017N04NM5

**Revision: 2020-03-22, Rev. 2.1**

Previous Revision

| Revision | Date       | Subjects (major changes since last revision)      |
|----------|------------|---------------------------------------------------|
| 2.0      | 2020-01-30 | Release of final version                          |
| 2.1      | 2020-03-22 | Update condition Id pulse, Features and footnotes |

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